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## November 2013



# FDD5N50NZ N-Channel UniFET<sup>TM</sup> II MOSFET **500 V, 4 A, 1.5** Ω

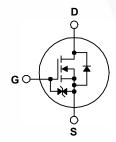
## **Features**

- R<sub>DS(on)</sub> = 1.38 Ω (Typ.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 2 A
- Low Gate Charge (Typ. 9 nC)
- Low C<sub>rss</sub> (Typ. 4 pF)
- 100% Avalanche Tested
- · Improved dv/dt Capability
- · ESD Imoroved Capability
- · RoHS Compliant

# Applications

- LCD/LED/PDP TV
- Lighting
- · Uninterruptible Power Supply

# Π-ΡΔΚ



Description

lasts.

## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

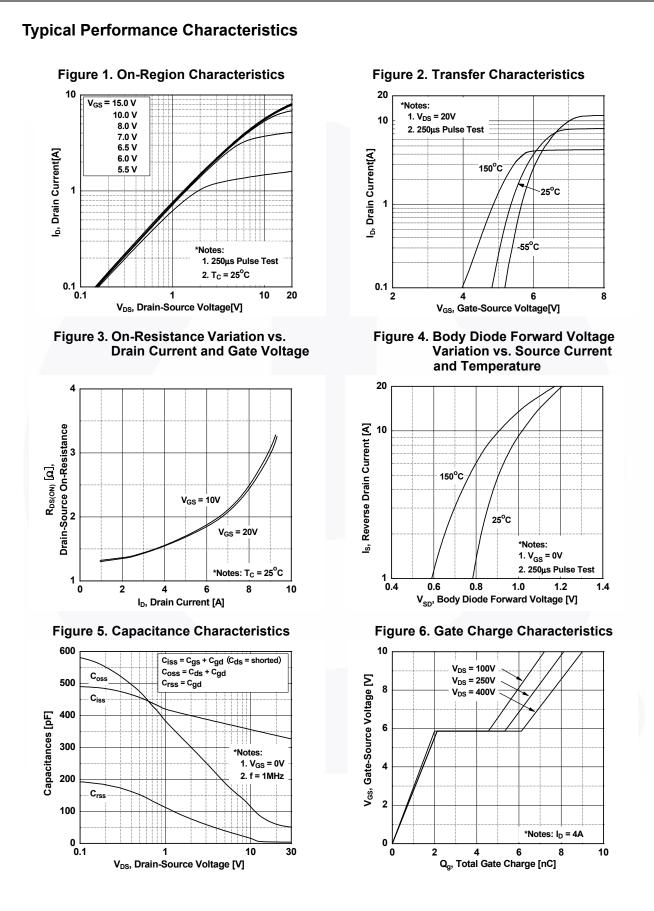
Symbol		FDD5N50NZTM	Unit		
V <sub>DSS</sub>	Drain to Source Voltage		500	V	
V <sub>GSS</sub>	Gate to Source Voltage		±25	V	
ID	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)	4		
		- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)	2.4	A	
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)	16	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		304	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)		4	А	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		6.2	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		10	V/ns	
P <sub>D</sub>	Devues Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$	62	W	
	Power Dissipation	- Derate Above 25°C	0.5	W/ <sup>o</sup> C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Tem	-55 to +150	°C		
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C	

# **Thermal Characteristics**

Symbol	Parameter	FDD5N50NZTM	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.0	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	90	0/00

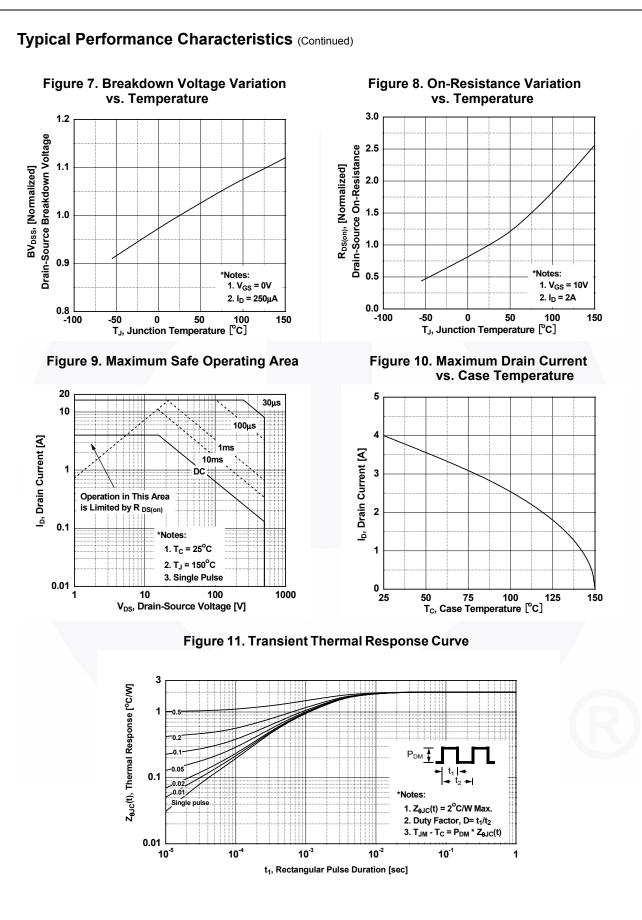
Part Nu	umber	Top Mark	Package	Packing Method	Reel Size	) Ta	ape Width	Qu	antity
FDD5N5	FDD5N50NZTM FDD5N50NZ		DPAK	· · ·				2500 units	
Electrica	al Chara	acteristics T <sub>C</sub> = 25°C u	unless other	rwise noted.					
Symbol		Parameter		Test Condition	s	Min.	Тур.	Max.	Unit
Off Chara	cteristics								
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage		lp =	= 250 μΑ, V <sub>GS</sub> = 0 V, T	- = 25°C	500	-	-	V
$\Delta BV_{DSS}$		wn Voltage Temperature				000			
$/\Delta T_J$	Coefficier		I <sub>D</sub> =	$I_D = 250 \ \mu$ A, Referenced to $25^{\circ}$ C		-	0.5	-	V/ºC
	Zoro Cot	Zara Cata Valtaga Drain Current		<sub>S</sub> = 500 V, V <sub>GS</sub> = 0 V		-	-	1	
IDSS	Zelu Gau	te Voltage Drain Current	V <sub>DS</sub>	$_{\rm S}$ = 400 V, T <sub>C</sub> = 125°C		-	-	10	μA
I <sub>GSS</sub>	Gate to E	Body Leakage Current	V <sub>GS</sub>	$_{\rm S}$ = ±25 V, V <sub>DS</sub> = 0 V		-	-	±10	μA
On Chara	ctoristics								
			V	- \/   - 250 A		3.0	-	5.0	V
V <sub>GS(th)</sub>		reshold Voltage		$_{\rm S} = V_{\rm DS}, I_{\rm D} = 250 \mu \text{A}$		3.0			
R <sub>DS(on)</sub>		ain to Source On Resistance		$_{\rm S}$ = 10 V, I <sub>D</sub> = 2 A		-	1.38	1.5	Ω
9 <sub>FS</sub>	Forwaru	Transconductance	V DS	<sub>S</sub> = 20 V, I <sub>D</sub> = 2 A		-	3.54	-	S
Dynamic (	Character	ristics							
C <sub>iss</sub>	Input Car	pacitance		$_{\rm S} = 25  \rm V,  V_{\rm GS} = 0  \rm V,$		-	330	440	pF
C <sub>oss</sub>		apacitance			-	50	70	pF	
C <sub>rss</sub>	'	Transfer Capacitance	T = 1	f = 1 MHz		-	4	6	pF
Q <sub>g(tot)</sub>		e Charge at 10V	Var	<sub>S</sub> = 400 V I <sub>D</sub> = 4 A,		-	9	12	nC
Q <sub>gs</sub>		Source Gate Charge		<sub>S</sub> = 400 V I <sub>D</sub> = 4 A, <sub>S</sub> = 10 V			2	-	nC
Q <sub>gd</sub>		Drain "Miller" Charge		5	(Note 4)	-	4	-	nC
					I		1		
Switching									
t <sub>d(on)</sub>		Delay Time			L	-	12	35	ns
t <sub>r</sub>		Rise Time		$_{\rm D} = 250 \text{ V}, \text{ I}_{\rm D} = 4 \text{ A},$	L	-	22	55	ns
t <sub>d(off)</sub>		Delay Time	vGS	$_{ m S}$ = 10 V, R <sub>G</sub> = 25 $\Omega$	_	-	28	65	ns
t <sub>f</sub>	Turn-Off I	Fall Time			(Note 4)	-	21	50	ns
Drain-Sou	rce Diod	e Characteristics							
I <sub>S</sub>		Continuous Drain to Source	- Diode For	ward Current			_	4	Α
		Maximum Pulsed Drain to Source Diode Forward Current			_	_	16	A	
V <sub>SD</sub>		Source Diode Forward Voltage				-	_	1.4	V
t <sub>rr</sub>		Recovery Time		$S_{\rm S} = 0 \text{ V}, I_{\rm SD} = 4 \text{ A},$		-	210	-	ns
Q <sub>rr</sub>		Recovery Charge		$V_{GS} = 0.0, I_{SD} = 4.4,$ $dI_{F}/dt = 100 A/\mu s$		-	1.1	-	μC

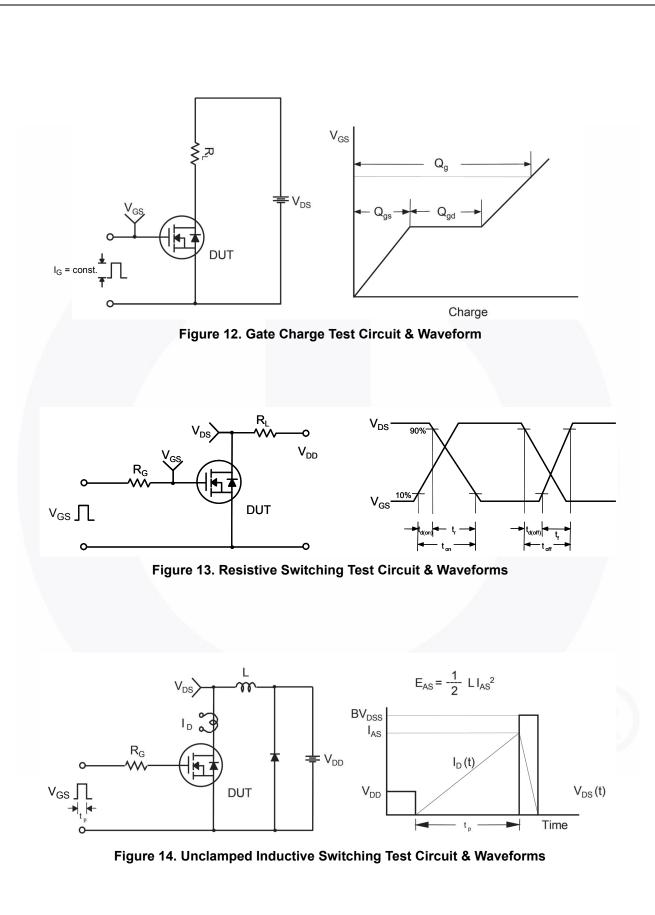
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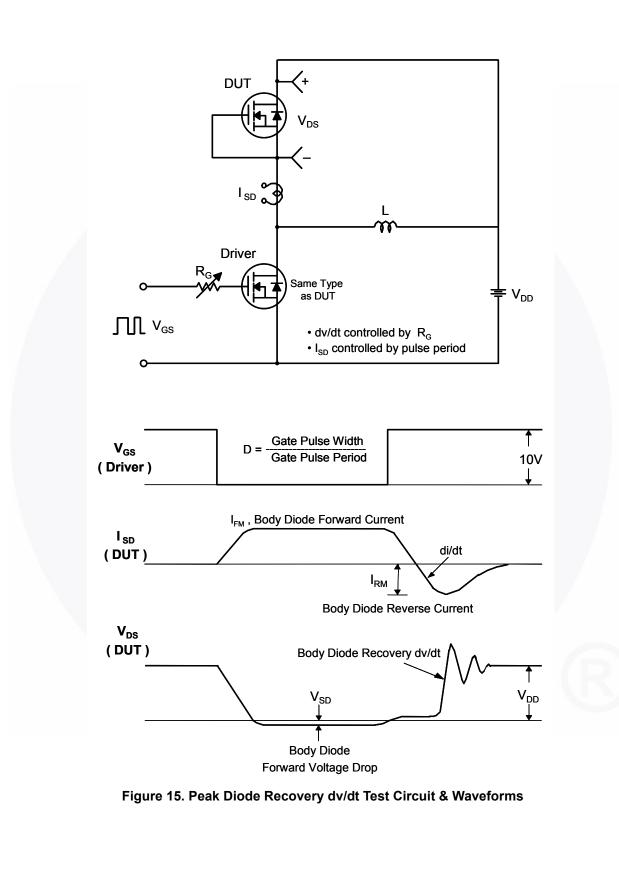


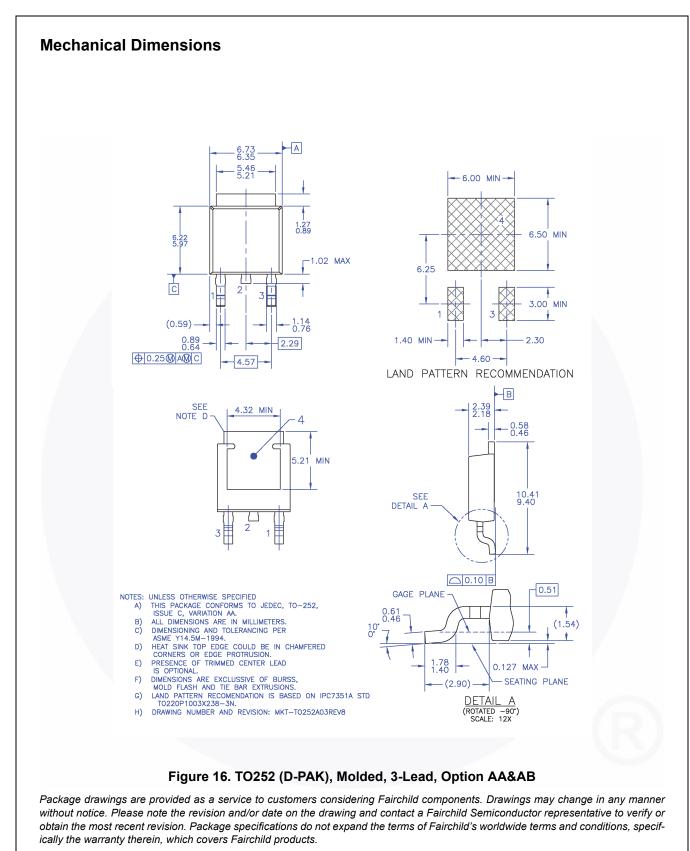
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